

General Description

The CMH65R105 is power MOSFET using Cmos's advanced super junction technology that can realize very low on resistance and gate charge. It will provide much high efficiency by using optimized charge coupling technology. These devices are well suited for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.

Features

- Low On-Resistance
- 100% avalanche tested
- RoHS Compliant

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	650	V
V_{GS}	Gate-Source Voltage	± 30	V
$I_D@T_C=25^{\circ}\text{C}$	Continuous Drain Current	31	A
$I_D@T_C=100^{\circ}\text{C}$	Continuous Drain Current	20	A
I_{DM}	Pulsed Drain Current	124	A
EAS	Single Pulse Avalanche Energy (Note 1)	1353	mJ
$P_D@T_C=25^{\circ}\text{C}$	Total Power Dissipation	278	W
T_{STG}	Storage Temperature Range	-55 to 150	$^{\circ}\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150	$^{\circ}\text{C}$

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	---	64	$^{\circ}\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance Junction-case	---	0.45	$^{\circ}\text{C}/\text{W}$

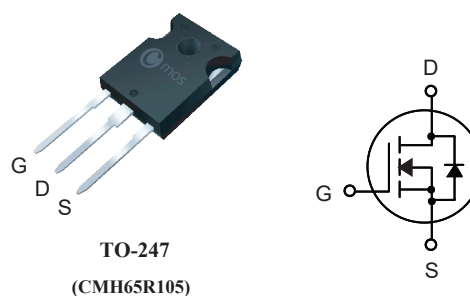
Product Summary

BVDSS	$R_{DS(on)}$ max.	ID
650V	100mΩ	31A

Applications

- Charger
- Adaptor
- Power Supply

TO-247 Pin Configuration



650V, 85mΩ typ., 31A N-Channel Super Junction Power MOSFET

Electrical Characteristics ($T_J=25^{\circ}\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DS}	Drain-Source Breakdown Voltage	$V_{GS}=0V$, $I_D=250\mu A$	650	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V$, $I_D=15A$	---	85	100	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250\mu A$	3	---	5	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=650V$, $V_{GS}=0V$	---	---	5	uA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 30V$, $V_{DS}=0V$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{DS}=10V$, $I_D=15A$	---	15	---	S
R_g	Gate Resistance	$V_{DS}=0V$, $V_{GS}=0V$, $f=1\text{MHz}$	---	1.1	---	Ω
Q_g	Total Gate Charge	$I_D=17A$	---	57	---	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=480V$	---	19.5	---	
Q_{gd}	Gate-Drain Charge	$V_{GS}=10V$	---	30	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DS}=400V$	---	63	---	ns
T_r	Rise Time	$V_{GS}=10V$	---	106	---	
$T_{d(off)}$	Turn-Off Delay Time	$I_D=17A$	---	132	---	
T_f	Fall Time	$R_G=27\Omega$	---	30	---	
C_{iss}	Input Capacitance	$V_{DS}=25V$, $V_{GS}=0V$, $f=1\text{MHz}$	---	2200	---	pF
C_{oss}	Output Capacitance		---	4120	---	
C_{rss}	Reverse Transfer Capacitance		---	350	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	$V_G=V_D=0V$, Force Current	---	---	31	A
I_{SM}	Pulsed Source Current		---	---	124	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V$, $I_S=17A$	---	0.91	1.4	V

Note :

1.The EAS data shows Max. rating .The test condition is $V_{DS}=80V$, $V_{GS}=10V$, $L=30\text{mH}$, $I_{AS}=9.5A$.

This product has been designed and qualified for the consumer market.

Cmos assumes no liability for customers' product design or applications.

Cmos reserves the right to improve product design ,functions and reliability without notice.

Typical Characteristics

